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## FEATURES

- IO-Link compliant slave transceiver
- Dual channel switches, configurable for high-side, low-side and push-pull operation with tristate function
- Configuration via pins or SPI interface
- Switches are current limited
- Switches, iC supply and feedback channel are protected against reverse polarity
- Output current of up to 150 mA per channel
- Parallel connection of both channels possible
- The channels can be inverted for antivalent output
- Sensor communication request function (IO-Link wake-up)
- Wide supply voltage range of 9 to 30 V
- Sensor parametrisation via a feedback channel (up to 30 V )
- Switching converters and linear regulators for $3.3 / 5 \mathrm{~V}$ voltage generation
- Error detection with hysteresis with excess temperature, overload and undervoltage
- Driver shut-down on all errors
- Error signalling at two open-collector outputs


## APPLICATIONS

- IO-Link slaves
- I/O sensor interface
- Digital sensors
- Light barriers
- Proximity switches


## PACKAGES

QFN24 4 mm x 4 mm

## BLOCK DIAGRAM



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## DESCRIPTION

iC-GF is a fully IO-Link compliant transceiver iC with two independent switching channels which enables digital sensors to drive peripheral elements, such as programmable logic controllers (PLC) and relays, for example. All functions are controlled either by pins or via SPI interface, with extended functionality and configurability in SPI mode.

The output switches can be configured for push-pull, high-side or low-side operation and share a common tri-state function (separate tri-state switching in SPI mode). The switches are designed to cope with high driver currents of at least $100 \mathrm{~mA}($ RSET $=6.8 \mathrm{k} \Omega)$, are current limited and also short-circuit-proof in that they shut down with excessive temperature or overload. The output current limit can be easily set with a resistor at pin ISET.

The protective overload feature is accomplished in a way so that capacitive loads can be switched with low repeat rates without the protective circuitry cutting in. In the event of excess temperature an error message is generated immediately.

Errors are signalled by two open-collector outputs: NOVL (for excess temperature and overloads) and NUVD (for low voltage at VBR or VCC resp. VCC3). The output switches are shut down with all types of errors.

To avoid error signalling during power-up, the output switches remain at high impedance for ca. 50 ms .

In SPI mode, the chip acts as an SPI slave and allows function configuration via register access. It also features a diagnostic register and supports communication requests ( $=$ IO-Link wake-up) at pin CFI, which generate interrupt signals at pin NDIAG.

The pins on the 24 V line side of the sensor interface (VBO, QP1, QN1, QP2, QN2, VN and CFI) are protected against reverse polarity. This makes any external reverse polarity protection diodes superfluous.
iC-GF features an integrated switching converter which generates voltages VCC ( 5 V ) and VCC3 (3.3 V) with the aid of two downstream linear regulators. For medium currents the inductor may as well be replaced by a resistor (e.g. $170 \Omega$ ), resulting though in a considerably less efficiency. If only a low current is required inductor LVH may be omitted completely; the linear regulators are then powered directly by VBR.

The switching regulator comes equipped with a spread spectrum oscillator to reduce interferences.

Input INV1 permits the input signal at channel 1 (IN1) to be inverted and if left unconnected, switches the chip into SPI mode.

The connected sensor can be parametrised using the feedback channel with a high voltage input (CFI $\rightarrow$ CFO).

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## PACKAGING INFORMATION

PIN CONFIGURATION QFN24 4 mm x 4 mm


PIN FUNCTIONS
No. Name Function
1 ISET Reference Current for current limitation of driver outputs
2 INV1 Inverting Input Channel 1 ESPI Enable SPI (pin open)
3 IN1 Input Channel 1 TX Transmission Input (SPI mode)
4 QCFG1 Configuration Input Channel 1 NCS Chip Select (SPI mode)

PIN FUNCTIONS

| No. | Name | Function |
| :---: | :---: | :---: |
| 5 | QCFG2 | Configuration Input Channel 2 |
|  | SCLK | Serial Clock (SPI mode) |
| 6 | IN2 | Input Channel 2 |
|  | MOSI | Master Output Slave Input (SPI mode) |
| 7 | OEN | Output Enable Input |
| 8 | NOVL | Overload Error Output |
|  | NDIAG | Diagnosis Output (SPI mode) |
| 9 | NUVD | Undervoltage Error Output |
|  | MISO | Master Input Slave Output (SPI mode) |
| 10 | CFO | Feedback Channel Output |
|  | RX | Transmission Output (SPI mode) |
| 11 | CFP | Configuration Input Feedback Channel |
| 12 | CFI | Feedback Channel Input |
| 13 | QP2 | High Side Switch Output Channel 2 |
| 14 | QN2 | Low Side Switch Output Channel 2 |
| 15 | VN | Ground |
| 16 | QN1 | Low Side Switch Output Channel 1 |
| 17 | QP1 | High Side Switch Output Channel 1 |
| 18 | VBO | Power Supply |
| 19 | VBR | Power Supply for switching converter |
| 20 | VHL | Inductor Switching Converter |
| 21 | VH | Input Linear Regulators |
| 22 | VCC | 5 V Sensor Supply |
| 23 | VCC3 | 3.3V Sensor Supply |
| 24 | GND | Sensor Ground |

The Thermal Pad is to be connected to a Ground Plane (VN) on the PCB.
Only pin 1 marking on top or bottom defines the package orientation (iC-GF label and coding is subject to change).

Do not short circuit line side ground (pin VN) and sensor side ground (pin GND). Otherwise interferences introduced at the line side may affect the sensor function.

PACKAGE DIMENSIONS QFN24 $4 \mathrm{~mm} \times 4 \mathrm{~mm}$
All dimensions given in mm.


## iC-GF <br> (2) IO-Link TRANSCEIVER

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## ABSOLUTE MAXIMUM RATINGS

Beyond these values damage may occur; device operation is not guaranteed. Absolute Maximum Ratings are no operating conditions! Integrated circuits with system interfaces, e.g. via cable accessible pins (I/O pins, line drivers) are per principle endangered by injected interferences, which may compromise the function or durability. The robustness of the devices has to be verified by the user during system development with regards to applying standards and ensured where necessary by additional protective circuitry. By the manufacturer suggested protective circuitry is for information only and given without responsibility and has to be verified within the actual system with respect to actual interferences.

| Item No. | Symbol | Parameter | Conditions | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| G001 | VBO | Power Supply at VBO | Referenced to lowest voltage of VN, VBR, QP1, QN1, QP2, QN2, CFI, VH, VHL; <br> DC $\mathrm{tp}<50 \mu \mathrm{~s}$ <br> Referenced to highest voltage of VN , VBR , QP1, QN1, QP2, QN2, CFI, VH, VHL; DC tp $<50 \mu \mathrm{~s}$ | $\begin{aligned} & -36 \\ & -52 \end{aligned}$ | $\begin{aligned} & 36 \\ & 52 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| G002 | I(VBO) | Current in VBO | $\begin{aligned} & \mathrm{DC} \\ & \operatorname{tp}<5 \mu \mathrm{~s}, \text { with } \mathrm{Cl}(\mathrm{VBR}) \end{aligned}$ | $\begin{aligned} & \hline-10 \\ & -10 \end{aligned}$ | $\begin{gathered} 600 \\ 5000 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| G003 | VBR | Voltage at VBR | Referenced to lowest voltage of VN, VBO, QP1, QN1, QP2, QN2, CFI, VH, VHL Referenced to highest voltage of VN, VBO, QP1, QN1, QP2, QN2, CFI, VH, VHL | -36 | 36 | $\mathrm{V}$ V |
| G004 | I(VBR) | Current in VBR | $\begin{aligned} & \mathrm{DC} \\ & \mathrm{tp}<5 \mu \mathrm{~s}, \text { with } \mathrm{Cl}(\mathrm{VBR}) \end{aligned}$ | $\begin{gathered} \hline-300 \\ -5000 \end{gathered}$ | $\begin{aligned} & 300 \\ & 300 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| G005 | $\mathrm{Cl}(\mathrm{VBR})$ | Capacitive load at VBR |  |  | 3.3 | $\mu \mathrm{F}$ |
| G006 | V(VH) | Voltage at VH | Referenced to lowest voltage of VN, VBR, VBO, QP1, QN1, QP2, QN2, CFI, VHL Referenced to highest voltage of VN, VBR, VBO, QP1, QN1, QP2, QN2, CFI, VHL | -36 | 36 | $\mathrm{V}$ V |
| G007 | I(VH) | Current in VH |  | -5 | 120 | mA |
| G008 | $\mathrm{V}(\mathrm{VHL})$ | Voltage at VHL | Referenced to lowest voltage of VN, VBR, VBO, QP1, QN1, QP2, QN2, CFI, VH Referenced to highest voltage of VN, VBR, VBO, QP1, QN1, QP2, QN2, CFI, VH | -36 | 36 | V <br> V |
| G009 | I(VHL) | Current in VHL |  | -150 | 5 | mA |
| G010 | V(VN) | Voltage at GND vs. VN |  | -2 | 2 | V |
| G011 | I(VN) | Current in VN | $\begin{aligned} & \mathrm{VN}<\mathrm{VBO} \\ & \mathrm{VN}>\mathrm{VBO} \end{aligned}$ | $\begin{gathered} -500 \\ -10 \end{gathered}$ | $\begin{gathered} 500 \\ 10 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| G012 | V() | Voltage at VCC, VCC3 |  | -0.3 | 7 | V |
| G013 | 1() | Current in VCC, VCC3 |  | -50 | 10 | mA |
| G014 | V() | Voltage at QP1, QN1, QP2, QN2 | Referenced to lowest voltage of VN, VBO, VBR, QP1, QN1, QP2, QN2, CFI, VH, VHL Referenced to highest voltage of VN, VBO, VBR, QP1, QN1, QP2, QN2, CFI, VH, VHL | -36 | 36 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| G015 | I() | Current in QP1, QP2 |  | -400 | 4 | mA |
| G016 | I() | Current in QN1, QN2 |  | -4 | 400 | mA |
| G017 | V (CFI) | Voltage at CFI | Referenced to lowest voltage of VN, VBO, VBR, QP1, QN1, QP2, QN2, VH, VHL Referenced to highest voltage of VN, VBO, VBR, QP1, QN1, QP2, QN2, VH, VHL | -36 | 36 | $\mathrm{V}$ <br> V |
| G018 | I(CFI) | Current in CFI |  | -4 | 4 | mA |
| G019 | V() | Voltage at INV1, QCFG1, QCFG2, IN1, IN2, OEN, CFP |  | -0.3 | 7 | V |
| G020 | I() | Current in INV1, QCFG1, QCFG2, IN1, IN2, OEN, CFP |  | -4 | 4 | mA |
| G021 | V() | Voltage at NOVL, NUVD, CFO |  | -0.3 | 7 | V |
| G022 | I() | Current in NOVL, NUVD, CFO |  | -5 | 20 | mA |
| G023 | V(ISET) | Voltage at ISET |  | -0.3 | 7 | V |
| G024 | I(ISET) | Current in ISET |  | -4 | 4 | mA |

All voltages are referenced to ground unless otherwise stated.
All currents flowing into the device pins are positive; all currents flowing out of the device pins are negative.

## ABSOLUTE MAXIMUM RATINGS (cont'd)

| Item <br> No. | Symbol | Parameter | Conditions | Min. |
| :--- | :--- | :--- | :---: | :---: | Max. | Unit |
| :---: |
| G025 |
| Vd() |

## THERMAL DATA

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}, \mathrm{RSET}=6.8 \mathrm{k} \Omega \pm 1 \%$, unless otherwise stated

| Item No. | Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| T01 | Ta | Operating Ambient Temperature Range (extended range on request) |  | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
| T02 | Rthja | Thermal Resistance Chip/Ambient | Surface mounted, thermal pad soldered to ca. $2 \mathrm{~cm}^{2}$ heat sink |  | 30 | 40 | K/W |

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## ELECTRICAL CHARACTERISTICS

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}, \mathrm{RSET}=6.8 \mathrm{k} \Omega \pm 1 \%$, unless otherwise stated

| Item No. | Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Total Device |  |  |  |  |  |  |  |
| 001 | VBO | Permissible Supply Voltage | Referenced to VN | 9 | 24 | 30 | V |
| 002 | I(VBO) | Supply Current in VBO | No load, VH connected to VBR, $I(Q P 1)=I(Q P 2)=0 \mathrm{~mA}, ~ Q P x$ switched on |  |  | 4.5 | mA |
| 003 | Vs(VBR) | Saturation Voltage at VBR | $\begin{aligned} & \mathrm{Vs}(\mathrm{VBR})=\mathrm{VBO}-\mathrm{V}(\mathrm{VBR}), \mathrm{l}(\mathrm{VH})=0 \mathrm{~mA} ; \\ & \mathrm{l}(\mathrm{VBR})=-20 \mathrm{~mA} \\ & \mathrm{l}(\mathrm{VBR})=-50 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{gathered} 0.8 \\ 1 \end{gathered}$ | $\begin{aligned} & \text { V } \\ & \text { V } \end{aligned}$ |
| 004 | I(VBR) | Maximum current in VBR | Switching converter current plus external current | -200 |  |  | mA |
| 005 | VH | Permissible Voltage at VH | $\mathrm{VH}>\mathrm{VHnr}$ | 8.4 |  | 30 | V |
| 006 | I(VH) | Supply Current in VH | $\begin{aligned} & \mathrm{VH}=8 \mathrm{~V} \text {, no load, } \mathrm{I}(\mathrm{VCC})=\mathrm{I}(\mathrm{VCC} 3)=0 \mathrm{~mA}, \\ & \mathrm{~V}(\mathrm{OEN})=\text { hi } \end{aligned}$ | 1.5 |  | 3 | mA |
| 007 | Vc() hi | Clamp Voltage hi at VBO, VBR vs. VN | l()$=10 \mathrm{~mA}$ | 36 |  |  | V |
| 008 | Vc()lo | Clamp Voltage lo at VBO, VBR vs. VN | $l()=-10 \mathrm{~mA}$ |  |  | -36 | V |
| 009 | Vc() hi | Clamp Voltage hi at QN1, QN2 vs. VN | I()$=1 \mathrm{~mA}, \mathrm{VBO}>\mathrm{VN}$ | 36 |  |  | V |
| 010 | Vc() lo | Clamp Voltage lo at QP1, QP2 vs VBO | I()$=-1 \mathrm{~mA}, \mathrm{VBO}>\mathrm{VN}$ |  |  | -36 | V |
| 011 | Vc() hi | Clamp Voltage hi at VN, VBO, VBR, QP1, QN1, QP2, QN1, CFI $\mathrm{VH}, \mathrm{VHL}$ vs. lowest voltage of VN, VBO, VBR, QP1, QN1, QP2, QN1, CFI, VH, VHL | l()$=1 \mathrm{~mA}$ | 36 |  |  | V |
| 012 | Vc() hi | Clamp Voltage hi at VCC, VCC3, ISET, INV1, IN1, IN2, QCFG1, QCFG2, OEN, CFO, CFP, NOVL, NUVD | l()$=1 \mathrm{~mA}$ | 7 |  |  | V |
| 013 | Vc() lo | Clamp Voltage lo at VCC, VCC3, ISET, INV1, IN1, IN2, QCFG1, QCFG2, OEN, CFO, CFP, NOVL, NUVD | $l()=-1 \mathrm{~mA}$ |  |  | -0.5 | V |
| 014 | RGND | Resistance GND to VN |  |  | 3 | 7 | $\Omega$ |
| Low-Side Switch QN1, QN2 |  |  |  |  |  |  |  |
| 101 | Vs()lo | Saturation Voltage lo at QN1, QN2 vs. VN | $\begin{aligned} & \text { RSET }=5.1 \mathrm{k} \Omega ; \\ & \mathrm{l}(\mathrm{)}=100 \mathrm{~mA} \\ & \mathrm{l}(\mathrm{O}=50 \mathrm{~mA} \\ & \mathrm{l}()=10 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{gathered} 1.2 \\ 0.65 \\ 0.3 \\ \hline \end{gathered}$ | $\begin{aligned} & V \\ & V \\ & V \end{aligned}$ |
| 102 | Isc()lo | Short-Circuit Current lo in QN1, QN2 | $\begin{aligned} & \mathrm{RSET}=6.8 \mathrm{k} \Omega, \mathrm{~V}()=3 \mathrm{~V} \ldots \mathrm{VBO} \\ & \mathrm{RSET}=5.1 \mathrm{k} \Omega, \mathrm{~V}()=4 \mathrm{~V} \ldots \mathrm{VBO} \end{aligned}$ | $\begin{aligned} & 100 \\ & 160 \end{aligned}$ | $\begin{aligned} & 140 \\ & 200 \end{aligned}$ | $\begin{aligned} & 180 \\ & 260 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| 103 | $\mathrm{Vol}($ )on | Overload Detection Threshold on | QN1, QN2 lo $\rightarrow$ hi; referenced to GND | 1.5 |  | 2.1 | V |
| 104 | Vol()off | Overload Detection Threshold off | QN1, QN2 hi $\rightarrow$ lo; referenced to GND | 1.5 |  | 1.8 | V |
| 105 | Vol()hys | Overload Detection Threshold Hysteresis | $\mathrm{Vol}($ )hys $=\mathrm{Vol}($ ()on -Vol() $\mathrm{off}$ | 0.1 |  |  | V |
| 106 | Ilk() | Leakage Current at QN1, QN2 | $\begin{aligned} & \mathrm{OEN}=1 \mathrm{lo}, \mathrm{VBO}=30 \mathrm{~V}, \mathrm{VN}=0, \\ & -6 \mathrm{~V}<\mathrm{V}(\mathrm{QNx})<36 \mathrm{~V} \end{aligned}$ | -100 |  | 100 | $\mu \mathrm{A}$ |
| 107 | SR() | Slew Rate (switch off $\rightarrow$ on) | $\mathrm{VBO}=30 \mathrm{~V}, \mathrm{Cl}=2.2 \mathrm{nF}$ |  |  | 45 | V/ $\mu \mathrm{s}$ |
| 108 | $\operatorname{Imax}()$ | Maximum Current in QN1, QN2 | $\mathrm{V}(\mathrm{ISET})=0 \mathrm{~V}, \mathrm{QNx}>3 \mathrm{~V}$ | 170 | 300 | 440 | mA |
| 109 | $\operatorname{Ir}()$ | Reverse Current in QN1, QN2 | QNx activated; $\mathrm{V}(\mathrm{QNx})=-6 \mathrm{~V}$ | -300 |  |  | $\mu \mathrm{A}$ |
| 110 | $\operatorname{lexc}()$ | Excitation Current | NEXC = 0 (see Fig. 9) | 300 |  | 540 | mA |
| 111 | texc | Excitation Time | NEXC = 0 (see Fig. 9) | 1.5 |  | 3.5 | $\mu \mathrm{s}$ |
| 112 | tdead | Dead Time | Push-pull configuration, QNx activation delay after QPx deactivation (see Fig. 9) | 1.2 |  | 2.8 | $\mu \mathrm{s}$ |

## iC-GF <br> (2) IO-Link TRANSCEIVER

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## ELECTRICAL CHARACTERISTICS

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}, \mathrm{RSET}=6.8 \mathrm{k} \Omega \pm 1 \%$, unless otherwise stated

| Item No. | Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| High-Side Switch QP1, QP2 |  |  |  |  |  |  |  |
| 201 | $\mathrm{Vs}($ ) hi | Saturation Voltage hi vs. VBO | $\begin{aligned} & \text { RSET }=5.1 \mathrm{k} \Omega ; \\ & \mathrm{I}()=-100 \mathrm{~mA} \\ & \mathrm{I}()=-50 \mathrm{~mA} \\ & \mathrm{I}()=-10 \mathrm{~mA} \end{aligned}$ | $\begin{gathered} -1.4 \\ -0.85 \\ -0.35 \end{gathered}$ |  |  | V V V |
| 202 | Isc()hi | Short-Circuit Current hi | $\begin{aligned} & \mathrm{RSET}=6.8 \mathrm{k} \Omega, \mathrm{~V}()=0 \ldots \mathrm{VBO}-3 \mathrm{~V} \\ & \mathrm{RSET}=5.1 \mathrm{k} \Omega, \mathrm{~V}()=0 \ldots \mathrm{VBO}-4 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -230 \\ & -325 \end{aligned}$ | $\begin{aligned} & \hline-150 \\ & -220 \end{aligned}$ | $\begin{aligned} & \hline-100 \\ & -140 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| 203 | Vol()on | Overload Detection Threshold on | QP1, QP2 hi $\rightarrow$ lo; referenced to VBO | -2.1 |  | -1.5 | V |
| 204 | Vol()off | Overload Detection Threshold off | QP1, QP2 lo $\rightarrow$ hi; referenced to VBO | -1.9 |  | -1.4 | V |
| 205 | Vol()hys | Overload Detection Threshold Hysteresis | Vol()hys = Vol()off - Vol()on | 0.1 |  |  | V |
| 206 | IIk() | Leakage Current at QP1, QP2 | $\begin{aligned} & \mathrm{OEN}=1 \mathrm{lo}, \mathrm{VBO}=30 \mathrm{~V}, \mathrm{VN}=0, \\ & -6 \mathrm{~V}<\mathrm{V}(\mathrm{QPx})<36 \mathrm{~V} \end{aligned}$ | -100 |  | 100 | $\mu \mathrm{A}$ |
| 207 | SR() | Slew Rate (switch off $\rightarrow$ on) | $\mathrm{VBO}=30 \mathrm{~V}, \mathrm{Cl}=2.2 \mathrm{nF}$ |  |  | 40 | $\mathrm{V} / \mathrm{\mu s}$ |
| 208 | Imax() | Maximum Current in QP1, QP2 | $\mathrm{V}(\mathrm{ISET})=0 \mathrm{~V}, \mathrm{VBO}-\mathrm{QPx}>4 \mathrm{~V}$ | -520 |  | -170 | mA |
| 209 | $\operatorname{Ir}()$ | Reverse Current in QP1, QP2 | QPx activated; V(QPx) = VBO...VBO + 6V |  |  | 1 | mA |
| 210 | lexc() | Excitation Current | NEXC = 0 (see Fig. 9) | -540 |  | -300 | mA |
| 211 | texc | Excitation Time | NEXC = 0 (see Fig. 9) | 1.5 |  | 3.5 | $\mu \mathrm{s}$ |
| 212 | tdead | Dead Time | Push-pull configuration, QPx activation delay after QNx deactivation (see Fig. 9) | 1.2 |  | 2.8 | $\mu \mathrm{s}$ |
| Short-Circuit/Overload Monitor |  |  |  |  |  |  |  |
| 301 | toldly | Time to Overload Message (NOVL $1 \rightarrow 0$, outputs tri-state) | Permanent overload (see Fig. 6) | 126 | 160 | 213 | $\mu \mathrm{s}$ |
| 302 | tolcl | Time to Overload Message Reset (NOVL $0 \rightarrow 1$, outputs active) | No overload (see Fig. 6) | 35 | 50 | 80 | ms |
| 303 | tdscr | Time to Communication Request acknowledge | SPI mode, ENSCR = 1, QCFGx(1:0)=01/10/11 | 70 |  | 90 | $\mu \mathrm{s}$ |
| 304 | tdnscr $_{\text {max }}$ | Maximum Time for no Communication Request acknowledge |  |  |  | 40 | $\mu \mathrm{s}$ |
| 305 | tdnscr $_{\text {min }}$ | Minimum Time for no Communication Request acknowledge |  | 151 |  |  | $\mu \mathrm{s}$ |
| VBO Voltage Monitor |  |  |  |  |  |  |  |
| 401 | VBOon | Turn-On Threshold VBO | Referenced to GND | 8 |  | 9 | V |
| 402 | VBOoff | Turn-Off Threshold VBO | Decreasing voltage VBO | 7.3 |  | 8.5 | V |
| 403 | VBOhys | Hysteresis | VBOhys = VBOon - VBOoff | 200 | 500 |  | mV |
| 404 | tuvdly | Time to Undervoltage Message (NUVD $1 \rightarrow 0$, switch tri-state) | Permanent undervoltage at VBR, VCC or VCC3 | 25 |  | 120 | $\mu \mathrm{s}$ |
| 405 | tuvcl | Time to Undervoltage Message Reset <br> (NUVD $0 \rightarrow 1$, switch active) | No undervoltage at VBR, VCC and VCC3 (see Fig. 6) | 35 | 50 | 80 | ms |
| Temperature Monitor |  |  |  |  |  |  |  |
| 501 | Toff | Overtemperature Shutdown (NOVL $1 \rightarrow 0$, switch tri-state) | Increasing temperature Tj | 130 |  | 165 | ${ }^{\circ} \mathrm{C}$ |
| 502 | ton | Overtemperature Shutdown Reset Delay <br> (NOVL $0 \rightarrow 1$, switch active) | Temperature Tj < Toff | 35 | 50 | 80 | ms |
| Inputs IN1/TX, IN2/MOSI, INV1/ENSPI, QCFG1/NCS, QCFG2/SCLK, OEN |  |  |  |  |  |  |  |
| 601 | Vt() hi | Input Threshold Voltage hi at IN1/TX, IN2/MOSI, OEN, SCLK, NCS |  |  |  | 2 | V |
| 602 | $\mathrm{Vt}($ ) lo | Input Threshold Voltage lo at IN1/TX, IN2/MOSI, OEN, SCLK, NCS |  | 0.8 |  |  | V |

## iC-GF

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## ELECTRICAL CHARACTERISTICS

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}, \mathrm{RSET}=6.8 \mathrm{k} \Omega \pm 1 \%$, unless otherwise stated

| Item No. | Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 603 | Vt()hys | Hysteresis at IN1/TX, IN2/MOSI, OEN, SCLK, NCS | Vt() $\mathrm{hys}=\mathrm{Vt}() \mathrm{hi}-\mathrm{Vt}() \mathrm{lo}$ | 200 | 280 |  | mV |
| 604 | lpd() | Pull-Down Current at IN1/TX, IN2/MOSI | V()$>0.4 \mathrm{~V}$ | 10 |  | 168 | $\mu \mathrm{A}$ |
| 605 | Ipd() | Pull-Down Current at NCS, SCLK | SPI mode, V()$>0.4 \mathrm{~V}$ | 10 |  | 40 | $\mu \mathrm{A}$ |
| 606 | Ipd(OEN) | Pull-Down Current at OEN | $\mathrm{V}(\mathrm{OEN})>0.4 \mathrm{~V}$ | 1 |  | 6 | $\mu \mathrm{A}$ |
| 607 | Vahi() | Input Threshold hi at QCFG1, QCFG2, INV1 |  | 52 | 64 | 69 | \%VCC3 |
| 608 | Vahi()hys | Hysteresis hi at QCFG1, QCFG2, INV1 |  | 3 |  | 7 | \%VCC3 |
| 609 | Valo() | Input Threshold lo at QCFG1, QCFG2, INV1 |  | 24 | 29 | 34 | \%VCC3 |
| 610 | Valo()hys | Hysteresis lo at QCFG1, QCFG2, INV1 |  | 3 |  | 7 | \%VCC3 |
| 611 | Voc() | Open Circuit Voltage at QCFG1, QCFG2, INV1 |  | 42 | 46.5 | 51 | \%VCC3 |
| 612 | Ri() | Internal Resistance at QCFG1, QCFG2, INV1 | Referenced to VCC3 Referenced to GND | $\begin{aligned} & 40 \\ & 40 \end{aligned}$ | $\begin{aligned} & 85 \\ & 85 \end{aligned}$ | $\begin{aligned} & 190 \\ & 190 \end{aligned}$ | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{k} \Omega \end{aligned}$ |
| 613 | tsup() | Permissible Spurious Pulse Width at IN1/TX, IN2, INV1/ESPI | No activity triggered, DEFAULT mode or SPI mode with FCFG(1:0) = 10 |  |  | 2.5 | $\mu \mathrm{s}$ |
| 614 | ttrig() | Required Pulse Width at IN1/TX, IN2, INV1/ESPI | Activity triggered, DEFAULT mode or SPI mode with FCFG(1:0) $=10$ | 6 |  |  | $\mu \mathrm{s}$ |
| 615 | tsup() | Permissible Spurious Pulse Width at QCFG1, QCFG2, OEN | No activity triggered, DEFAULT mode or SPI mode with FCFG(1:0) = 10 |  |  | 5 | $\mu s$ |
| 616 | ttrig() | Required Pulse Width at QCFG1, QCFG2, OEN | Activity triggered, DEFAULT mode or SPI mode with FCFG(1:0) $=10$ | 12 |  |  | $\mu \mathrm{s}$ |
| 617 | tpio | Propagation Delay IN1 $\rightarrow$ QP1, QN1 IN2 $\rightarrow$ QP2, QN2 | INV1 = low or high, DEFAULT mode or SPI mode with $\operatorname{FCFG}(1: 0)=10$ | 2.4 |  | 10 | $\mu \mathrm{s}$ |
| Error Output NOVL/NDIAG, NUVD/MISO |  |  |  |  |  |  |  |
| 701 | Vs()lo | Saturation Voltage lo at NOVL, NUVD | DEFAULT mode, $\mathrm{I}(\mathrm{)}=1.0 \mathrm{~mA}$ |  |  | 0.4 | V |
| 702 | $\mathrm{Vs}($ ) lo | Saturation Voltage lo at NDIAG | SPI mode, I()$=1.0 \mathrm{~mA}$ |  |  | 0.4 | V |
| 703 | Isc()lo | Short Circuit Current lo in NOVL, NUVD | DEFAULT mode, V()$=0.4 \mathrm{~V}$...VCC | 1.2 |  | 25 | mA |
| 704 | Isc()lo | Short Circuit Current lo in NDIAG | SPI mode, V()$=0.4 \mathrm{~V}$...VCC | 1.2 |  | 25 | mA |
| 705 | IIk() | Leakage Current in NOVL, NUVD | DEFAULT mode, V()$=0 \mathrm{~V} . . . \mathrm{VCC}$, no error | -10 |  | 10 | $\mu \mathrm{A}$ |
| 706 | IIk() | Leakage Current in NDIAG | SPI mode, V() = 0 V...VCC, no error | -10 |  | 10 | $\mu \mathrm{A}$ |
| 707 | $\mathrm{Vs}($ ) hi | Saturation Voltage high at MISO | $\begin{aligned} & \text { SPI mode, I(MISO) }=-2 \mathrm{~mA}, \\ & \text { Vs(MISO) hi }=\mathrm{VCC} 3-\mathrm{V}(\mathrm{MISO}) \end{aligned}$ |  |  | 0.4 | V |
| 708 | Vs()lo | Saturation Voltage low at MISO | SPI mode, $\mathrm{I}(\mathrm{MISO})=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| 709 | Isc()hi | Short Circuit current hi in MISO | SPI mode, $\mathrm{V}(\mathrm{MISO})=0 . . . \mathrm{VCC} 3-0.4 \mathrm{~V}$ | -40 |  |  | mA |
| 710 | Isc()lo | Short Circuit current lo in MISO | SPI mode, $\mathrm{V}(\mathrm{MISO})=0.4 \mathrm{~V}$...VCC3 |  |  | 90 | mA |
| 711 | tr(MISO) | Rise Time | $\begin{aligned} & \text { SPI mode, CI(MISO) }=30 \mathrm{pF}, \\ & 0 \rightarrow 90 \% \text { VCC3 } \end{aligned}$ |  |  | 22 | ns |
| 712 | tf(MISO) | Fall Time | SPI mode, $100 \rightarrow 10 \% \mathrm{VCC3}$ |  |  | 16 | ns |
| Feedback Channel CFI to CFO/RX |  |  |  |  |  |  |  |
| 801 | Vt1(CFI)hi | Input Threshold 1 hi at CFI | VBR < 18V | 59 | 66 | 74 | \%VBR |
| 802 | Vt1(CFI)lo | Input Threshold 1 lo at CFI | VBR < 18V | 44 | 50 | 56 | \%VBR |
| 803 | Vt2(CFI)hi | Input Threshold 2 hi at CFI | VBR > 18V | 10.5 | 11.3 | 12 | V |
| 804 | Vt2(CFI)lo | Input Threshold 2 lo at CFI | VBR > 18V | 8.3 | 9 | 10.5 | V |
| 805 | Vt()hys | Hysteresis at CFI | Vt(CFI)hys $=\mathrm{Vt}(\mathrm{CFI}) \mathrm{hi}-\mathrm{Vt}(\mathrm{CFI}) \mathrm{lo}$ | 1 |  |  | V |
| 806 | Ipu(CFI) | Pull-Up Current at CFI | DEFAULT mode: CFP = hi, $\mathrm{V}(\mathrm{CFI})=0 . . . \mathrm{VBR}-3 \mathrm{~V}$ SPI mode: $\mathrm{POL}=1, \mathrm{ENPUD}=1$ | -300 |  | -40 | $\mu \mathrm{A}$ |

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## ELECTRICAL CHARACTERISTICS

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}, \mathrm{RSET}=6.8 \mathrm{k} \Omega \pm 1 \%$, unless otherwise stated

| Item No. | Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 807 | Ipd(CFI) | Pull-Down Current at CFI | DEFAULT mode: CFP $=10, \mathrm{~V}(\mathrm{CFI})=3 \mathrm{~V} . . . \mathrm{VBR}$ SPI mode: $\mathrm{POL}=0$, ENPUD $=1$ | 40 |  | 300 | $\mu \mathrm{A}$ |
| 808 | tpcf | Propagation Delay CFI $\rightarrow$ CFO/RX | V(CFO/RX) $=10 \leftrightarrow 90 \%$, DEFAULT mode or SPI mode with $\operatorname{FCFI}(1: 0)=01$ | 2.4 |  | 10 | $\mu \mathrm{s}$ |
| 809 | Vs()lo | Saturation Voltage lo at CFO/RX | Open collector mode, I(CFO/RX) = 1.0 mA |  |  | 0.4 | V |
| 810 | Isc()lo | Short Circuit Current lo in CFO/RX | Open collector mode, $\mathrm{V}(\mathrm{CFO} / R X)=0.4 \mathrm{~V}$...VCC | 1.2 |  | 25 | mA |
| 811 | IIk() | Leakage Current at CFO/RX | Open collector mode, $\mathrm{V}(\mathrm{CFO} / \mathrm{RX})=0 \mathrm{~V} \ldots \mathrm{VCC}$, CFO/RX = off | -10 |  | 10 | $\mu \mathrm{A}$ |
| 812 | Vt(CFP)hi | Input Threshold Voltage hi at CFP |  |  |  | 2 | V |
| 813 | Vt(CFP)lo | Input Threshold Voltage lo at CFP |  | 0.8 |  |  | V |
| 814 | Vt(CFP)hys | Hysteresis at CFP | Vt(CFP)hys = Vt(CFP) hi - Vt(CFP)lo | 200 | 280 |  | mV |
| 815 | $\operatorname{lpd}(\mathrm{CFP})$ | Pull-Down Current at CFP | $\begin{aligned} & \mathrm{V}(\mathrm{CFP})=0.4 \mathrm{~V} . . . \mathrm{Vt}(\mathrm{CFP}) \mathrm{lo} \\ & \mathrm{~V}(\mathrm{CFP})>\mathrm{Vt}(\mathrm{CFP}) \mathrm{hi} \end{aligned}$ | $\begin{aligned} & 30 \\ & 10 \end{aligned}$ |  | $\begin{gathered} 168 \\ 40 \end{gathered}$ | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| 816 | tsup(CFI) | Permissible Spurious Pulse Width at CFI | No activity triggered, DEFAULT mode or SPI mode with $\operatorname{FCFI}(1: 0)=01$ |  |  | 2.5 | $\mu \mathrm{s}$ |
| 817 | ttrig(CFI) | Required Pulse Width at CFI | Activity triggered, DEFAULT mode or SPI mode with $\operatorname{FCFI}(1: 0)=01$ | 6 |  |  | $\mu \mathrm{s}$ |
| 818 | tsup(CFP) | Permissible Spurious Pulse Width at CFP | No activity triggered |  |  | 5 | $\mu \mathrm{s}$ |
| 819 | ttrig(CFP) | Required Pulse Width at CFP | Activity triggered | 12 |  |  | $\mu \mathrm{s}$ |
| 820 | $\begin{aligned} & \text { Ipd(CFI)+ } \\ & \text { lik(QPx) } \end{aligned}$ | Pull-Down Current at CFI plus leakage current at QPx | $\mathrm{V}(\mathrm{CFI})=3 \mathrm{~V} . . . \mathrm{VBR}, \mathrm{OEN}=1 \mathrm{lo}$; DEFAULT mode: CFP = lo SPI mode: $\mathrm{POL}=0, E N P U D=1$ | 20 |  |  | $\mu \mathrm{A}$ |
| 821 | $\mathrm{Vs}(\mathrm{RX}) \mathrm{hi}$ | Saturation Voltage high at RX | $\begin{aligned} & \text { SPI mode, ENOD = 0, I(RX) = }-2 \mathrm{~mA}, \\ & \mathrm{Vs}(R X) \mathrm{hi}=\mathrm{VCC} 3-\mathrm{V}(R X) \end{aligned}$ |  |  | 0.4 | V |
| 822 | Vs(RX)lo | Saturation Voltage low at RX | SPI mode, ENOD $=0, \mathrm{l}(\mathrm{RX})=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| 823 | $\operatorname{lsc}(\mathrm{RX}) \mathrm{hi}$ | Short Circuit current hi in RX | $\begin{aligned} & \text { SPI mode, ENOD = 0, } \\ & \mathrm{V}(\mathrm{RX})=0 \ldots \mathrm{VCC} 3-0.4 \mathrm{~V} \end{aligned}$ | -40 |  |  | mA |
| 824 | Isc(RX)lo | Short Circuit current lo in RX | SPI mode, ENOD $=0, \mathrm{~V}(\mathrm{RX})=0.4 \mathrm{~V} . . . \mathrm{VCC} 3$ |  |  | 90 | mA |
| 825 | $\operatorname{tr}(\mathrm{RX})$ | Rise Time at RX | $\begin{aligned} & \text { SPI mode, ENOD }=0, C L(R X)=30 \mathrm{pF}, \\ & 0 \rightarrow 90 \% \text { VCC3 } \end{aligned}$ |  |  | 22 | ns |
| 826 | $\mathrm{tf}(\mathrm{RX})$ | Fall Time at RX | $\begin{aligned} & \text { SPI mode, ENOD }=0, \mathrm{CL}(\mathrm{RX})=30 \mathrm{pF}, \\ & 100 \rightarrow 10 \% \mathrm{VCC} 3 \end{aligned}$ |  |  | 22 | ns |
| Step Down Converter VHL, VH |  |  |  |  |  |  |  |
| 901 | VHn | Nominal Voltage at VH | $\begin{aligned} & \mathrm{Ri}(\mathrm{LVH})<1.1 \Omega, \mathrm{CVH}=1 \mu \mathrm{~F} ; \\ & \mathrm{LVH}=22 \mu \mathrm{H}, \mathrm{I}(\mathrm{VH})=0 \ldots . .50 \mathrm{~mA} \\ & \mathrm{LVH}=100 \mu \mathrm{H}, \mathrm{I}(\mathrm{VH})=0 \ldots . .100 \mathrm{~mA}, \mathrm{VBO}>10 \mathrm{~V} \end{aligned}$ | 6.3 | 6.7 | 7.4 | V |
| 902 | VHnr | Nominal Voltage at VH, LVH replaced by a resistor | $\mathrm{R}=170 \Omega, \mathrm{l}(\mathrm{VH})=0 \ldots 10 \mathrm{~mA}$ | 6.3 |  | 8.4 | V |
| 903 | $\mathrm{la}(\mathrm{VHL})$ | max. DC Cut-Off Current in VHL |  | -200 |  |  | mA |
| 904 | $\mathrm{Va}(\mathrm{VH})$ | Cut-Off Voltage at VH | $\mathrm{Va}(\mathrm{VH})>\mathrm{VHn}$ | 6.5 | 7.3 | 8.4 | V |
| 906 | $\mathrm{Vs}(\mathrm{VHL})$ | Saturation Voltage at VHL vs. VBR | $\begin{aligned} & \mathrm{l}(\mathrm{VHL})=-50 \mathrm{~mA} \\ & \mathrm{l}(\mathrm{VHL})=-150 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 0.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 1.1 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| 907 | $\mathrm{Vf}(\mathrm{VHL})$ | Saturation Voltage at VHL vs. GND | $\begin{aligned} & \mathrm{Vf}(\mathrm{VHL})=\mathrm{V}(\mathrm{GND})-\mathrm{V}(\mathrm{VHL}) ; \\ & \mathrm{l}(\mathrm{VHL})=-50 \mathrm{~mA} \\ & \mathrm{l}(\mathrm{VHL})=-150 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 0.6 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 2.9 \end{aligned}$ | $\begin{aligned} & \text { V } \\ & \text { V } \end{aligned}$ |
| 908 | Ilk(VHL) | Leakage Current at VHL | $\mathrm{VHL}=\mathrm{lo}, \mathrm{V}(\mathrm{VHL})=\mathrm{V}(\mathrm{VH})$ | -20 |  | 20 | $\mu \mathrm{A}$ |
| 909 | $\eta \mathrm{VH}$ | Efficiency of VH switching regulator | $\begin{aligned} & \mathrm{Ri}(\mathrm{LVH})<1.1 \Omega ; \\ & \mathrm{LVH}=22 \mu \mathrm{H}, \mathrm{I}(\mathrm{VH})=0 \ldots 50 \mathrm{~mA}, \mathrm{~V}(\mathrm{VBR})= \\ & 12 \ldots . .30 \mathrm{~V} \\ & \mathrm{LVH}=100 \mu \mathrm{H}, \mathrm{I}(\mathrm{VH})=0 \ldots 100 \mathrm{~mA}, \mathrm{~V}(\mathrm{VBR})= \\ & 12 \ldots . .24 \mathrm{~V} \end{aligned}$ | 70 |  |  | \% |

## iC-GF

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## (10)Hous

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## ELECTRICAL CHARACTERISTICS

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}, \mathrm{RSET}=6.8 \mathrm{k} \Omega \pm 1 \%$, unless otherwise stated

| Item No. | Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Series Regulator VCC |  |  |  |  |  |  |  |
| A01 | VCCn | Nominal Voltage at VCC | $1(\mathrm{VCC})=-50 \ldots 0 \mathrm{~mA}, \mathrm{VH}=\mathrm{VHn}$ | 4.75 | 5 | 5.25 | V |
| A02 | CVCC | Required Capacitor at VCC vs. GND |  | 150 |  |  | nF |
| A03 | RiCVCC | Maximum Permissible Internal Resistance of capacitor at VCC |  |  |  | 1 | $\Omega$ |
| A04 | VCCon | VCC Monitor Threshold hi |  | 89 |  | 98 | \%VCCn |
| A05 | VCCoff | VCC Monitor Threshold lo | Decreasing Voltage at VCC | 80 |  | 90 | \%VCCn |
| A06 | VCChys | Hysteresis | VCChys = VCCon - VCCoff | 50 | 500 |  | mV |
| Series Regulator VCC3 |  |  |  |  |  |  |  |
| B01 | VCC3n | Nominal Voltage at VCC3 | $\mathrm{I}(\mathrm{VCC} 3)=-50 \ldots 0 \mathrm{~mA}, \mathrm{VH}=\mathrm{VHn}$ | 3.1 | 3.3 | 3.5 | V |
| B02 | CVCC3 | Required Capacitor at VCC3 vs. GND |  | 150 |  |  | nF |
| B03 | RiCVCC3 | Maximum Permissible Internal Resistance of capacitor at VCC3 |  |  |  | 1 | $\Omega$ |
| B04 | VCC3on | VCC3 Monitor Threshold hi |  | 89 |  | 98 | $\begin{gathered} \% \\ \text { VCC3n } \end{gathered}$ |
| B05 | VCC3off | VCC3 Monitor Threshold lo | Decreasing Voltage at VCC3 | 80 |  | 90 | $\begin{gathered} \% \\ \text { VCC3n } \end{gathered}$ |
| B06 | VCC3hys | Hysteresis | VCC3hys = VCC3on - VCC3off | 50 | 200 |  | mV |
| Oscillator |  |  |  |  |  |  |  |
| C01 | $\mathrm{fos}_{\text {ss }}$ | Spread Spectrum Oscillator Frequency | Average value from 64 clock cycles | 0.88 |  | 1.5 | MHz |
| C02 | Tosss | Single Clock Cycle Period (spread spectrum oscillator) |  | 0.571 |  | 1.35 | $\mu \mathrm{s}$ |
| C03 | fos | Fixed Oscillator Frequency | $\mathrm{Tj}=27^{\circ} \mathrm{C}$ | $\begin{gathered} 1.5 \\ 1.53 \end{gathered}$ |  | $\begin{gathered} 2.5 \\ 2.43 \end{gathered}$ | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |
| Reference and Bias |  |  |  |  |  |  |  |
| D01 | V(ISET) | Voltage at ISET | $\mathrm{Tj}=27^{\circ} \mathrm{C}$ | 1.12 | 1.24 | 1.29 | V |
| D02 | Isc(ISET) | Short Circuit Current in ISET | $\mathrm{V}($ ISET $)=0 \mathrm{~V}, \mathrm{Tj}=27^{\circ} \mathrm{C}$ | -0.55 | -0.4 | -0.28 | mA |
| D03 | rlbeg | Transmission Ratio for driver output current limitation | $\begin{aligned} & \operatorname{lmax}(\mathrm{QP} 1)=\operatorname{Imax}(\mathrm{QP} 2)=\operatorname{Imax}(\mathrm{QN} 1)= \\ & \operatorname{Imax}(\mathrm{QN} 2)=\mathrm{I}(\mathrm{ISET}) * \text { rlbeg, } \\ & \mathrm{RSET}=5.1 \ldots 20 \mathrm{k} \Omega \end{aligned}$ |  | 800 |  |  |

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## OPERATING REQUIREMENTS: SPI Interface

Operating Conditions: VBO $=9 \ldots 30 \mathrm{~V}$ (referenced to VN ), $\mathrm{Tj}=-40 \ldots 125^{\circ} \mathrm{C}$

| Item <br> No. | Symbol | Parameter | Conditions |  | Min. |
| :--- | :--- | :--- | :--- | :---: | :---: | Max.


$\qquad$


Figure 1: SPI write cycle (top) and read cycle (bottom)

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## DESCRIPTION OF FUNCTIONS

iC-GF has two independent switching channels which enables digital sensors to drive peripheral elements. They are designed to cope with high driver currents. The switches are reverse-polarity protected, feature a free-wheeling circuit for inductive loads and a saturation voltage minimising system.

## Reverse polarity protection

The pins VBO, QPx, QNx, VN and CFI on the line side of the chip are reverse polarity protected. As far as the maximum voltage ratings are not exceeded, no possible supply combination at the line side pins can damage the chip.


Figure 2: QNx characteristic when active


Figure 3: QPx characteristic when active

## Output characteristics of Q1, Q2

The switching channels are current limited to a value set by the external resistor RSET (cf. Electrical Characteristics No. D03). If pin ISET is short circuited to GND, the current limitation will be set to a maximum value (cf. Electrical Characteristics Nos. 108, 208). The current limitation works only for voltages higher than 4 V at QNx resp. lower than VBO -4 V at QPx. For smaller output voltages the current limitation is reduced in order to minimise the saturation voltages without increasing the power dissipation. Figures 2 and 3 show the characteristic of the switching channels when activated. Region " A " is the saturation range, where the current limitation is not fully active yet and region " B " is the current limited range. Region " C " corresponds to the free-wheeling
circuit activated. The switching channels are designed so that QNx can only sink current and QPx can only source current (no reverse current).

## Free-wheeling circuit for inductive loads

The free-wheeling circuit is always present and does not depend on the current output status. It is activated by voltages higher than 36 V at QNx referenced to VN or lower than -36 V at QPx referenced to VBO. In that case the correspondent channel will switch on without current limitation (see Figure 4).


Figure 4: Free-wheeling characteristic

## Dead time

In order to avoid current flow between high- and lowside switch in push-pull configuration, a dead time $t_{\text {dead }}$ is implemented as shown in Figure 5 (cf. Electrical Characteristics Nos. 112 and 212).


Figure 5: Propagation delay

## Overload detection

To protect the device against excessive power dissipation due to high currents the switches are clocked if an overload occurs. If a short circuit is detected, i.e. if the voltage at the switch output overshoots or undershoots Overload Detection Threshold off (cf. Electrical Characteristics Nos. 104 and 204), the switches are shut down for a typical 50 ms (cf. Electrical Characteristics No. 302) and the current flow thus interrupted.

The level of power dissipation depends on the current and the time during which this current flows. A current which fails to trigger the overload detection is not critical; high current can also be tolerated for a short period
and with low repeat rates. This is particularly important when switching capacitive loads (charge/discharge currents).


Figure 6: Permanent short circuit


Figure 7: Overload

So that this is possible a shared back-end integrator follows the switches for the purpose of overload detection. This integrator is an 8-bit counter which is updated together with the oscillator clock. If an overload is detected on one channel the counter is incremented by 1 ; an overload on both channels increments the counter by 2 . If no overload is apparent the counter is decremented by 1 every 10 clock pulses. A maximum duty cycle - without deactivation of the switches - of $1: 10$ results if one channel is overloaded. Only when this ratio is exceeded the counter can reach its maximum value, generating an error message at NOVL and deactivating the switches.

## Undervoltage detection

iC-GF features two separate undervoltage detectors: voltage monitoring at VBO and voltage monitoring at

VCC and VCC3. Both undervoltage detectors are filtered against spurious events smaller than $25 \mu \mathrm{~s}$ (cf. Electrical Characteristics No. 404). In case of a valid undervoltage event (longer than $25 \mu \mathrm{~s}$ ) both QPx and QNx are unconditionally brought to high impedance for at least 35 ms (cf. Electrical Characteristics No. 405) resp. as long as the duration of the undervoltage situation.

## Digital filtering at inputs

To obtain high noise immunity the pins QCFGx, INV1/ESPI, IN1/TX, IN2, OEN, CFI and CFP have a digital input filter. Figure 5 shows this filter time $t_{\text {trig }}$ for INx (cf. Electrical Characteristics Nos. 613 to 616 and 816 to 819).

## Feedback channel CFI-CFO

iC-GF implements a feedback channel which permits a communication from the line side to the sensor side. High voltage digital signals at CFI are converted into low voltage (open-collector) levels at CFO.

## Spread spectrum oscillator

To reduce the electromagnetic interference generated by the switching converter (pin VHL) a spread spectrum oscillator has been introduced. Here the switch is not triggered by a fixed frequency but by a varying 32 step frequency mix. Generated interference is then distributed across the frequency spectrum with its amplitude reduced at the same time.

## Configuration mode

Leaving pin INV1 unconnected (cf. Table 1) selects SPI mode for configuration. All functions implemented in DEFAULT mode are also available in SPI mode plus some additional functions, available in SPI mode only.

| Mode Select |  |
| :---: | :---: |
| INV1 | MODE |
| L | DEFAULT |
| H | DEFAULT |
| Z | SPI |

Table 1: Operating mode configuration

## iC-GF

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## DEFAULT MODE

## Enabling the switches

After power-up, the output switches remain at high impedance for ca. 50 ms . Setting pin OEN to low unconditionally disables all four output switches. Other functions of the chip (like the DC/DC converter or the feedback channel) remain enabled.

## Configuring the switches

The functionality of the switches is determined by the pins QCFG1 and QCFG2. A voltage at QCFGx which is lower than Va() lo (cf. Figure 8) deactivates the relevant high-side switches; with a voltage higher than Va() hi the relevant low-side switches are deactivated. Both high-side and low-side switches are activated, when the pin is left open.


Figure 8: Levels at QCFG1/QCFG2 for switch configuration

| CHANNEL 1 |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| IN1 | QCFG1 | INV1 | OEN | QN1 | QP1 |  |
| X | X | X | L | off | off |  |
| L | Z | L | H | on | off |  |
| H | Z | L | H | off | on |  |
| L | Z | H | H | off | on |  |
| H | Z | H | H | on | off |  |
| L | H | L | H | off | off |  |
| H | H | L | H | off | on |  |
| L | H | H | H | off | on |  |
| H | H | H | H | off | off |  |
| L | L | L | H | off | off |  |
| H | L | L | H | on | off |  |
| L | L | H | H | on | off |  |
| H | L | H | H | off | off |  |

Table 2: Function table Channel 1

| CHANNEL 2 |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| IN2 | QCFG2 | OEN | QN2 | QP2 |
| X | X | L | off | off |
| L | Z | H | on | off |
| H | Z | H | off | on |
| L | H | H | off | off |
| H | H | H | off | on |
| L | L | H | off | off |
| H | L | H | on | off |

Table 3: Function table Channel 2 (INV1 = H, L)

Tables 2 and 3 show the switch configuration for both channels, with respect to the input pins.

## Feedback channel CFI-CFO configuration

The feedback channel CFI-CFO polarity can be configured via pin CFP (see table 4). This pin also sets the pull-up/down current at pin CFI.

| FEEDBACK CHANNEL |  |  |  |
| :---: | :---: | :---: | :---: |
| CFI | CFP | CFO | PULL at CFI pin |
| $H$ | H | Z | UP |
| $H$ | L | L | DOWN |
| L | H | L | UP |
| L | L | Z | DOWN |

Table 4: Function table Feedback Channel

## Undervoltage signalling

Undervoltage at VBO, VCC or VCC3 is signalled at pin NUVD. A valid undervoltage event is signalled at NUVD for at least 35 ms (cf. Electrical Characteristics No. 405) resp. as long as the duration of the undervoltage situation.

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## SPI MODE

In SPI mode the iC-GF is configured and operated using the on-chip registers. Additionally there is a status register, where chip events are logged. If any of the status bits is set to high, the low-active open-drain pin NDIAG is activated, e.g. for interrupt generation for micro controllers. The SPI mode is activated when the pin INV1 is left open and the filter time (cf. Electrical Characteristic No. 614) has elapsed. This enables communication with the iC-GF via an SPI protocol using pins MISO, MOSI, SCLK and NCS. After power-up, the output switches remain at high impedance for ca. 50 ms . During this time, the SPI interface can be used to set the desired output configuration.

## Switch enable

There are three different ways of enabling/disabling the output switches in SPI mode: pin mode, register mode and mixed mode. In pin mode (TXEN = "11") or register mode (TXEN = "00") the OEN pin acts as a common enable for both switching channels. The OEN register on the other hand enables or disables each switch separately.

| Switch enable |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| OEN pin | TXEN(1:0) | OEN(1:0) | Qx2 | Qx1 |
| 0 | $00 / 11$ | XX | disabled | disabled |
| 1 | $00 / 11$ | 01 | disabled | enabled |
| 1 | $00 / 11$ | 10 | enabled | disabled |
| 1 | XX | 11 | enabled | enabled |
| X | XX | 00 | disabled | disabled |
| 0 | 01 | 0 X | disabled | disabled |
| 0 | 01 | 1 X | enabled | disabled |
| 0 | 10 | X 0 | disabled | disabled |
| 0 | 10 | X 1 | disabled | enabled |
| 1 | 01 | 01 | disabled | enabled |
| 1 | 01 | 10 | enabled | disabled |
| 1 | 10 | 01 | disabled | enabled |
| 1 | 10 | 10 | enabled | disabled |

Table 5: Switch enable, QCFGx = "00"

In mixed mode (TXEN = "01" or "10") the OEN pin acts as an enable only for the channel for which the TXEN bit is set to "1". The OEN register enables or disables each switching channel separately. Table 5 summarises these configurations.

## Switch control

Each switch can be operated by the OUTD register or the input pin TX. The register TXEN selects register OUTD or the pin TX for switch control.

A " 0 " in the register TXEN sets the corresponding switch to be controlled by the relevant bit of the register OUTD.

| TXEN(1:0) | Addr. 0x00; bit (5:4) | R/W 01 |
| :---: | :---: | :---: |
| x0 | Channel 1 controlled by OUTD(0) |  |
| x1 | Channel 1 controlled by TX |  |
| 0x | Channel 2 controlled by OUTD (1) |  |
| 1x | Channel 2 controlled by TX |  |

Table 6: Transmit enable

| OUTD(1:0) |  |
| :--- | :--- |
| x0 | Addr. 0x00; bit (1:0) |
| x1 | Channel 1: push-pull low resp. high/low-side off |
| $0 x$ | Channel 1: push-pull high resp. high/low-side on |
| 1x | Channel 2: push-pull low resp. high/low-side off high resp. high/low-side on |

Table 7: Output data with INV = "00"

## Switch configuration

The configuration of the switches is determined by the registers QCFG1 and QCFG2; either as high-side, lowside, push-pull or high impedance (disabled).

| QCFG1(1:0) | Addr. 0x01; bit (5:4) | R/W 11 |
| :--- | :--- | :--- |
| 00 | disabled |  |
| 01 | low-side switch |  |
| 10 | high-side switch |  |
| 11 | push-pull |  |

Table 8: Switch configuration Channel 1

| QCFG2(1:0) | Addr. 0x01; bit (7:6) | R/W 11 |
| :---: | :---: | :---: |
| 00 | disabled |  |
| 01 | low-side switch |  |
| 10 | high-side switch |  |
| 11 | push-pull |  |

Table 9: Switch configuration Channel 2

INV inverts the corresponding switching channel.

| INV(1:0) |  | Addr. 0x03; bit (5:4) |
| :--- | :--- | :--- |$\quad$ R/W 00 0

Table 10: Invert Output

Table 11 summarises the above configurations for channel 1.
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| CHANNEL 1 |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TXEN(0) | QCFG1(1:0) | TX | OUTD(0) | INV(0) | QN1 | QP1 |
| 0 | 01 | x | 0 | 0 | off | off |
| 0 | 01 | x | 0 | 1 | on | off |
| 0 | 01 | x | 1 | 0 | on | off |
| 0 | 01 | x | 1 | 1 | off | off |
| 0 | 10 | x | 0 | 0 | off | off |
| 0 | 10 | x | 0 | 1 | off | on |
| 0 | 10 | x | 1 | 0 | off | on |
| 0 | 10 | x | 1 | 1 | off | off |
| 0 | 11 | x | 0 | 0 | on | off |
| 0 | 11 | x | 0 | 1 | off | on |
| 0 | 11 | x | 1 | 0 | off | on |
| 0 | 11 | x | 1 | 1 | on | off |
| 1 | 01 | L | x | 0 | off | off |
| 1 | 01 | L | x | 1 | on | off |
| 1 | 01 | H | x | 0 | on | off |
| 1 | 01 | H | x | 1 | off | off |
| 1 | 10 | L | x | 0 | off | off |
| 1 | 10 | L | x | 1 | off | on |
| 1 | 10 | H | x | 0 | off | on |
| 1 | 10 | H | x | 1 | off | off |
| 1 | 11 | L | x | 0 | on | off |
| 1 | 11 | L | x | 1 | off | on |
| 1 | 11 | H | x | 0 | off | on |
| 1 | 11 | H | x | 1 | on | off |

Table 11: Function table for channel 1 in SPI mode

| FCFI(1:0) | Addr. 0x02; bit (1:0) | R/W 01 |
| :--- | :--- | :--- |
| 00 | Filter disabled |  |
| 01 | $4 \mu \mathrm{~s}$ filtering (8 CLKs) |  |
| 10 | $7 \mu \mathrm{~s}$ filtering (14 CLKs) |  |
| 11 | $16 \mu \mathrm{~s}$ filtering (32 CLKs) |  |

Table 12: CFI filter configuration

| FCFG(1:0) |  | Addr. 0x02; bit (3:2) |
| :--- | :--- | :--- |$\quad$ R/W 10 $\quad$.

Table 13: TX and OEN filter configuration

Digital filtering at inputs
The digital input filters can be configured with the reg-
ister FCFG for pins TX and OEN and register FCFI for pin CFI. Figure 9 shows the filter time $t_{\text {trig }}$ for TX (cf. Electrical Characteristics Nos. 613 to 616 and 816 to 819).

## Excitation current

Using register NEXC an additional current $l_{\text {exc }}$ can be activated for driving capacitive loads. Figure 9 shows the characteristic of one channel with the excitation current enabled (cf. Electrical Characteristics Nos. 110, 111, 210 and 211).

| NEXC(1:0) | Addr. 0x03; bit (1:0) | R/W 11 |
| :---: | :---: | :---: |
| x0 | Excitation for channel 1 enabled |  |
| x1 | Excitation for channel 1 disabled |  |
| 0x | Excitation for channel 2 enabled |  |
| 1x | Excitation for channel 2 disabled |  |

Table 14: Excitation current configuration

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Figure 9: Dynamic characteristic

## Feedback channel CFI-RX configuration

In SPI mode RX is a standard CMOS output, which can also be configured as an open-drain output, using the register bit ENOD (cf. Table 15).

| ENOD | Addr. 0x01; bit (0) | R/W 1 |
| :--- | :--- | :--- |
| 0 | Push-pull output |  |
| 1 | Open-drain output |  |

Table 15: RX configuration

The polarity of the feedback channel CFI-RX can be configured using register bit POL (cf. Table 16). Pin CFP has no function in SPI mode. The POL bit also controls the pull-up/down current at CFI. The INVPUD bit changes the polarity of the pull-up/down current at CFI independent of the other configurations. The pul-l-up/down current can be disconnected completely - if
required - by means of register bit ENPUD (cf. Table 17).

| POL |  |
| :--- | :--- |
| 0 | CFI hi $\rightarrow$ RX hi (ENOD = 0) resp. on (ENOD $=1$ ) <br> Pull-down current (ENPUD = 1, INVPUD = 0) <br> CFI hi $\rightarrow$ RX lo (ENOD = 0) resp. off (ENOD $=1)$ <br> Pull-up current (ENPUD = 1, INVPUD = 0) |

Table 16: Input polarity

| ENPUD | Addr. 0x01; bit (3) | R/W 1 |
| :--- | :--- | :--- |
| 0 | CFI pull-up/down disabled |  |
| 1 | CFI pull-up/down enabled |  |

Table 17: Enable pull-up/down

The state of the CFI pin (high or low) is mapped independent of POL to the register bit IND (see table 18). Changes at CFI can be logged in the status bit CFED (and signalled at pin NDIAG), if the bit ENCFD is set to high. The CFED bit is cleared after read.

| IND | Addr. Ox00; bit (7) | R |
| :--- | :--- | :--- |
| 0 | Input Signal at CFI is low |  |
| 1 | Input Signal at CFI is high |  |

Table 18: CFI status

| ENCFD | Addr. 0x02; bit (7) | R/W 0 |
| :---: | :---: | :---: |
| 0 | CFED Disabled |  |
| 1 | CFED Enabled |  |

Table 19: Enable edge detection at CFI

Table 20 summarizes the behaviour of the feedback channel CFI in SPI mode.
Feedback channel CFI

| CFI | POL | INVPUD | IND | RX (ENOD = 0) | RX (ENOD = 1) | Current at CFI |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | off | down |
| 1 | 0 | 0 | 1 | 1 | on | down |
| 0 | 1 | 0 | 0 | 1 | on | up |
| 1 | 1 | 0 | 1 | 0 | off | up |
| 0 | 0 | 1 | 0 | 0 | off | up |
| 1 | 0 | 1 | 1 | 1 | on | up |
| 0 | 1 | 1 | 0 | 1 | on | down |
| 1 | 1 | 1 | 1 | 0 | off | down |

Table 20: Function table of feedback channel CFI in SPI mode (ENPUD = 1)

## Overload detection

In SPI mode the counter decrements of the overload detection can be programmed with the register DU-

TYC(1:0), resulting in different overload duty cycles at the switching channels. The maximum allowed over-

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load time cannot be changed (cf. Electrical Characteristics No. 301), only the average value (duty cycle).

| DUTYC(1:0) | Addr. 0x03; | bit (3:2) |
| :--- | :--- | :--- |
| 00 | Ruty cycle of $1: 4$ | R/W 10 |
| 01 | Duty cycle of $1: 8$ |  |
| 10 | Duty cycle of $1: 10$ |  |
| 11 | Duty cycle of $1: 15$ |  |

Table 21: Overload detection duty cycle

## Spread spectrum oscillator

In SPI mode the spread spectrum operation can be disabled with the register ENRND.

| ENRND | Addr. 0x02; bit (4) | R/W 1 |
| :--- | :--- | :--- |
| 0 | Spread spectrum disabled |  |
| 1 | Spread spectrum enabled |  |

Table 22: Spread spectrum oscillator

## Pull-down currents

In SPI mode the pins NCS and SCLK do only have a pull-down current.

## Undervoltage signalling

Undervoltage at VBO, VCC or VCC3 is signalled in the status register UVD. A valid undervoltage event is signalled for the duration of the undervoltage situation resp. for at least 35 ms (Electrical Characteristics No. 405). Only during this time, the undervoltage event is signalled in the status register UVD. It will also be signalled at pin NDIAG. Any confirmed undervoltage situation at VCC or VCC3 will reset the configuration register which will also be signalled in the status register INITR; this bit is cleared when read. The SPI interface is not affected by any of the undervoltage events and is still operable, provided that the supply level at VCC is high enough.

| UVD(1:0) | Addr. 0x04; bit (7:6) | R 00 |
| :--- | :--- | :--- |
| 00 | No undervoltage detected |  |
| 01 | Undervoltage at VCC or VCC3 |  |
| 10 | Undervoltage at VBO |  |
| 11 | Undervoltage at VBO and VCC/VCC3 |  |

Table 23: Undervoltage detection

## Communication requests

The communication request function (IO-Link wake-up) allows interrupt signal generation by means of a well defined short-circuit on one of the switching channels. This requires the relevant switching channel (Q1 or Q2) to be connected to the feedback channel input CFI (see Figure 10). The communication request would be a
contrasting pulse, forcing the selected line to a state different than the current one (short-circuit).


Figure 10: Communication request pulse generation

Bit ENSCR enables the communication request function. By default, communication requests are detected at channel 1 (Q1 connected to CFI). For detection at channel 2, the bit SCR2 must be set. As shown in Figure 11, a communication request is acknowledged when its duration is inside a defined window (cf. Electrical Characteristics No. 303). The relevant threshold voltages are given in the Electrical Characteristics Nos. 801, 802, 803 and 804. The example in Table 26 shows channel 1 used for communication request.

| ENSCR | Addr. 0x02; bit (6) | R/W 0 |
| :--- | :--- | :--- |
| 0 | Communication request disabled |  |
| 1 | Communication request enabled |  |

Table 24: Enable communication request

| SCR2 | Addr. 0x02; bit (5) | R/W 0 |
| :--- | :--- | :--- |
| 0 | Communication request in channel 1 |  |
| 1 | Communication request in channel 2 |  |

Table 25: Communication request channel select

An acknowledged communication request will be logged in the status bit SCR and signalled at pin NDIAG. The communication request is not affected by the output disabling (neither by pin nor register OEN), but is disabled if the configuration in QCFGx is set to "00".

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| Sensor Communication request SCR |  |  |
| :---: | :---: | :---: |
| OUTD(1:0) | QCFG1(1:0) | CFI (70...90 $\mu$ s pulse) |
| $\mathrm{x0}$ | 11 | High |
| x 1 | 11 | Low |
| x 0 | 10 | High |
| x 1 | 10 | Low |
| x 0 | 01 | Low |
| x 1 | 01 | High |

Table 26: Communication request at channel 1, OEN = 1, SCR2 = 0, ENSCR = 1, INVx = 0

Figure 11: Communication request timing:
A: Communication request ignored
B: Uncertainty range
C: Communication request acknowledged

## SPI INTERFACE

The SPI interface uses the pins NCS, SCLK, MISO and MOSI. The protocol is shown in Figures 12 and 13. A communication frame consists of one addressing byte and one data byte. Bit 7 of the address byte is used for selecting a read (set to 1 ) or a write (set to 0 ) operation. The other bits are used for register addressing. It is possible to transmit several bytes consecutively, if the

NCS signal is not reset and SCLK keeps clocking. The address is internally incremented after each transmitted byte. Once the address has reaches the last register (0x04), the following 3 increments will read and write dummy data. After that addressing will start again at $0 \times 00$. The required timing for the SPI signals during a communication is shown in Figure 1.


Figure 12: SPI write data


Figure 13: SPI read data

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## REGISTERS

## Configuration overview

The configuration bytes are readable and writeable, with the exception of the IND bit (adr $0 \times 00$ ). The diagnostic register is read only. After reading, the bits CFED, INITRAM and SCR are reset. The bits OVT,

OVL(1:0) and UVD(1:0) are set to high during the respective error condition and stay high for least 35 ms after the condition has been removed (Electrical Characteristics Nos. 302, 405). Tables 27, 28 and 28 show an overview of the registers, accessible in SPI mode.

| Register | Address | Bits | Default | Description |
| :--- | :---: | ---: | ---: | :--- |
| DUTY | $0 \times 03$ | $3: 2$ | 10 | Duty cycle configuration for overload detection |
| ENCFD | $0 \times 02$ | 7 | 0 | Enable logging of changes at CFI |
| ENOD | $0 \times 01$ | 0 | 1 | Enable Open-Drain output at RX pin |
| ENPUD | $0 \times 01$ | 3 | 1 | Enable pull-up/down current at CFI pin |
| ENRND | $0 \times 02$ | 4 | 1 | Enable spread spectrum oscillator |
| ENSCR | $0 \times 02$ | 6 | 0 | Enable communication requests |
| FCFG | $0 \times 02$ | $3: 2$ | 10 | Filter configuration for TX and OEN |
| FCFI | $0 \times 02$ | $1: 0$ | 01 | Filter configuration for CFI |
| IND | $0 \times 00$ | 7 | R/O | CFI status (independent of POL), r/o |
| INV | $0 \times 03$ | $5: 4$ | 00 | Switching channel inversion |
| INVPUD | $0 \times 01$ | 1 | 0 | Invert pull-up/down configuration at CFI |
| NEXC | $0 \times 03$ | $1: 0$ | 11 | Enable excitation current for capacitive loads |
| OEN | $0 \times 00$ | $3: 2$ | 11 | Switching channel enable |
| OUTD | $0 \times 00$ | $1: 0$ | 00 | Output data for the switching channels |
| POL | $0 \times 01$ | 2 | 0 | Polarity inversion at CFI |
| QCFG1 | $0 \times 01$ | $5: 4$ | 11 | Switching channel 1 configuration |
| QCFG2 | $0 \times 01$ | $7: 6$ | 11 | Switching channel 2 configuration |
| TXEN | $0 \times 00$ | $5: 4$ | 01 | Channel control select (register or pin) |
| SCR2 | $0 \times 02$ | 5 | 0 | Communication request channel selection |

Table 27: Overview of the configuration registers

| Register | Address | Bits | Description |
| :--- | :---: | ---: | :--- |
| INITR | $0 \times 04$ | 0 | Register reset |
| SCR | $0 \times 04$ | 1 | Communication request acknowledged |
| CFED | $0 \times 04$ | 2 | Change detection at CFI |
| OVT | $0 \times 04$ | 3 | Overtemperature |
| OVL(0) | $0 \times 04$ | 4 | Overload Channel 1 |
| OVL(1) | $0 \times 04$ | 5 | Overload Channel 2 |
| UVD(0) | $0 \times 04$ | 6 | Undervoltage VCC resp. VCC3 |
| UVD(1) | $0 \times 04$ | 7 | Undervoltage VBO |

Table 28: Overview of the diagnostic register (read only)

| OVERVIEW |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Addr | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| 0x00 | IND |  | TXEN(1:0) |  | OEN(1:0) |  | OUTD(1:0) |  |
| 0x01 | QCFG2(1:0) |  | QCFG1(1:0) |  | ENPUD | POL | INVPUD | ENOD |
| 0x02 | ENCFD | ENSCR | SCR2 | ENRND | FCFG(1:0) |  | FCFI(1:0) |  |
| 0x03 |  |  | INV(1:0) |  | DUTY(1:0) |  | NEXC(1:0) |  |
| 0x04 | UVD(1:0) |  | OVL(1:0) |  | OVT | CFED | SCR | INITR |

## APPLICATION NOTES

## Setup for medium and small currents at VCC/VCC3

 For medium output currents at VCC/VCC3 the inductor of the switching converter may as well be replaced by a resistor (see Fig. 14), resulting though in a considerably less efficiency (power dissipation!) and an elevated noise level at VH and thus at VCC/VCC3.

Figure 14: LVH replaced by a resistor

For small output currents the switching converter can be bypassed completely (see Fig. 15). Please note the significantly higher power dissipation in that case.


Figure 15: Switching converter bypassed


Figure 16: SPI Mode in extremely noisy environments

## Noise environments

In extremely noisy environments, additional blocking capacitors (CEM1, CEM2) can be used to ensure SPI mode (see Fig. 16).

## Output protection

Figures 18 to 21 show some common configurations with different wire counts and the respective additional protective circuitry against transients on the transmission line; suggested values as follows:

| CQx: | 1 nF |
| :--- | :--- |
| CCFI: | 1 nF |
| CVBO: | 100 nF |
| TVSx: | TVS diodes |

Depending on the power supply, cable, and bypass capacitors, currents in the range of 10 A may flow through the TVS diode at VBO on power-up. Make sure that the chosen TVS diode clamps the voltage at such currents to values lower than the dynamic absolute maximum ratings given in G001.

For protection against fast transients at VBO, insert a series resistor in the VBO line (see Fig. 17).

Choosing the ratio of CVBO / CVBR to e.g. 1:1 may also reduce the stress in the switch between VBO and VBR.


Figure 17: Series resistor in the VBO line

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Figure 18: Three-wire interface with feedback (parallel operated channels optional)


Figure 19: Four-wire interface with feedback at channel 2


Figure 20: Four-wire interface with separate feedback (parallel operated channels optional)


Figure 21: Five-wire interface

## DEMO BOARD

iC-GF comes with a demo board for test purposes. Figures 22 and 23 show both the schematic and the component side of the demo board.


Figure 22: Schematic of the demo board


Figure 23: Demo board (component side)
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## DESIGN REVIEW: Function Notes

| IC-GF Y1 | No. Function, parameter/code <br> 1 Overload detection, <br> Electrical Characteristics Nos. 104/204 <br> Oveription and application notes <br> High-Side or in Low can occur with one or both output channels Q1 and Q2 in <br> This sensitivity on signal timing does not exist when configuring both output <br> channels as Push-Pull. <br> In general the Overload detection depends on load, signal frequency and slew and <br> is programmable through SPI. At Overload detection the output channels are set to <br> high impedance during typical 50 ms and thereafter iC-GF returns to normal mode. <br> There is no distinction between various effects and reasons causing Overload <br> detection which has to be handled within the application as for protection at <br> excessive power dissipation.  <br> 2 SPI Frequency, <br> Operating Condition Item No. 1010 <br> At $\mathrm{Tj}=-40$ to $-20^{\circ} \mathrm{C}$ the maximum SPI frequency is limited to 3 MHz.  |  |
| :--- | :--- | :--- |

Table 30: Notes on chip functions regarding iC-GF chip release Y1

| iC-GF Y2 |  |  |
| :--- | :--- | :--- |
| No. | Function, parameter/code | Description and application notes |
| 1 | SPI Frequency, <br> Operating Condition Item No. I010 | The maximum SPI frequency is limited to 4 MHz. |

Table 31: Notes on chip functions regarding iC-GF chip release Y2

## REVISION HISTORY

| Rel. | ${\text { Rel. } \text { Date }^{*}}^{\text {Chapter }}$ | Modification | Page |  |
| :--- | :--- | :--- | :--- | :---: |
| E1 | $2014-07-08$ | ELECTRICAL <br> CHARACTERISTICS | $104,204:$ Footnote regarding overload detection removed | 10,11 |
| E1 |  | OPERATING REQUIRE- <br> MENTS: SPI Interface | $1010:$ Changed to 4 MHz | 15 |


| Rel. | Rel. Date $^{*}$ | Chapter | Modification | Page |
| :--- | :---: | :--- | :--- | :---: |
| F1 | $2015-03-16$ | ELECTRICAL <br> CHARACTERISTICS | $106,206:$ Simplified leakage current specification | 10,11 |
| F1 |  | ELECTRICAL <br> CHARACTERISTICS | $901,909:$ VH load current extended to 100 mA with $100 \mu \mathrm{H}$ coil | 13 |


| Rel. | Rel. Date | Chapter | Modification | Page |
| :--- | :--- | :--- | :--- | :--- |
| G1 | $2021-01-08$ | PACKAGES | CSP option removed | 1 |
|  |  | ABSOLUTE MAXIMUM RATINGS | G001, G002, G004, G007, G015, G016 updated | 6 |
|  |  | ELECTRICAL <br> CHARACTERISTICS | $003:$ Parameter/Conditions corrected | 8 |
|  |  | ELECTRICAL <br> CHARACTERISTICS | 004 added | 8 |
|  |  | REGISTERS | Bit names corrected | 8 |
|  |  | APPLICATION NOTES | Updated and expanded | 22 |


| Rel. | ${\text { Rel. } \text { Date }^{*}}^{\text {Chapter }}$ | Modification | Page |  |
| :--- | :--- | :--- | :--- | :--- |
| G2 | $2021-10-14$ | ELECTRICAL <br> CHARACTERISTICS | $909:$ Conditions for LVH $=100 \mu \mathrm{H}$ updated | 11 |
|  |  | ELECTRICAL <br> CHARACTERISTICS | C03: Conditions corrected | 12 |

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## ORDERING INFORMATION

| Type | Package | Order Designation |
| :--- | :--- | :--- |
| iC-GF | QFN24 $4 \mathrm{~mm} \times 4 \mathrm{~mm}($ RoHS compliant $)$ <br> Evaluation Board | iC-GF QFN24 <br> iC-GF EVAL GF1D |

Please send your purchase orders to our order handling team:

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[^0]:    * Release Date format: $Y Y Y Y-M M-D D$

